

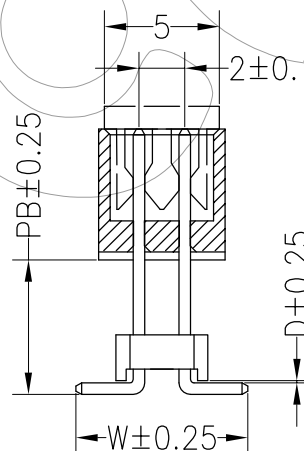
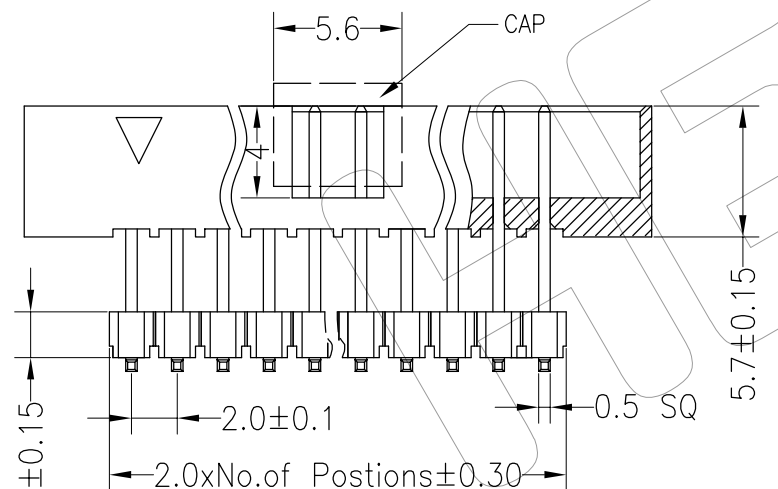
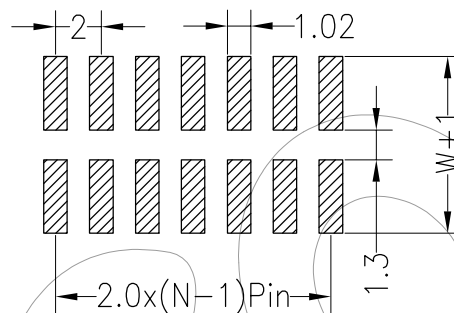
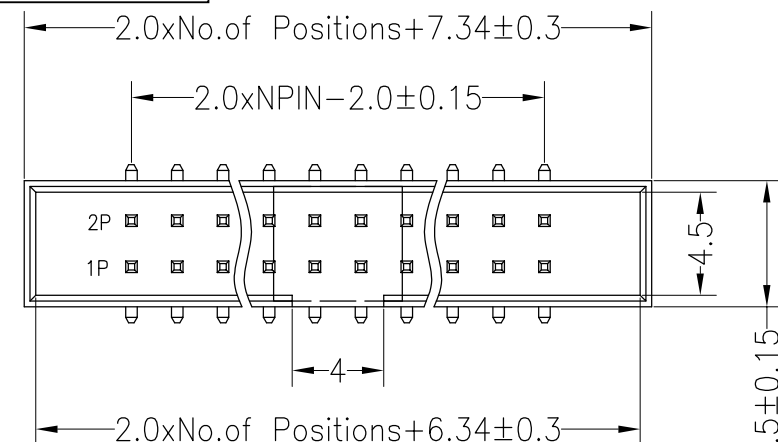
RoHS

Recommended P.C.B Layout(Top Side)
(PCB BOARD TOLERANCE ± 0.05)

SPECIFICATIONS

Rated Current:1.5AMP
Contact Resistance:20m Ω Max
Withstand Voltage:400V AC/DC
Insulation Resistance:800M Ω Min
Operation Temperature:-40°C to +105°C

Contact Material:Brass
Contact Plating:Au or Sn Over Ni
Insulator Material:Polyester(UL94V-0)
Standard: PA6T
Max.Processing Temp: 230°C for 30-60 seconds
(260°C for 10 seconds)



Dimension antitheses list			
ITEM	PB	D	W
Standard	2.50	0	6.50
Alternate			

Ordering Information
HC-BH520 XX M XX X BD00 X 01(2)

No. of Pins
6--64

Contact Plating
G0:Gold Flash
G2:3U" Gold
G2:5U" Gold
G3:10U" Gold
G4:15U" Gold
G5:30U" Gold
S0:Gold Flash/Tin

Insulator Material
Option
A=BK-PBT
B=BK-PA66
C=BK-PA6T
D=BK-PA46
E=BK-PA9T
F=BK-LCP

Packing
0=PE Bag
A=Tray
T=Tube
P=Tube+Cap
R=Reel+Cap

OPERATION

X.X ± 0.30
X.XX ± 0.20
X.XXX ± 0.10
Angle $\pm 3^\circ$
DIM TOL

DRAW

Ayang

CHECK

APPROVE

SCALE

FIT

UNIT

mm

SIZE

A4

SHEET

1/1

PROJ.

1/1

HECON 东莞市禾康电子有限公司
DONGGUAN HECON ELECTRONICS CO.,LTD

PART NO.

HC-BH520XXMXXBD00X01

TITLE:

2.0mm H5.7+2.0Pin Header SMT Npin
Box Header